



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 10/701,957

Filed: November 5, 2003

For: METHOD FOR SAWING WAFERS
EMPLOYING MULTIPLE INDEXING
TECHNIQUES FOR MULTIPLE DIE
DIMENSIONS AND DICING APPARATUS

Confirmation No.: 8101

Examiner: M. Rachuba

Group Art Unit: 3723

Attorney Docket No.: 2269-2874.20US
(96-0032.17/US)

Notice of Allowance Mailed:

March 31, 2005

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Person making Deposit: Steve Wong

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Amendments to the Specification begin on page 3 of this paper.

A Listing of the Claims begins on page 6 of this paper.

Remarks begin on page 10 of this paper.